



60V N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BV _{DSS}	R _{DS(ON)} Max	I _D Max Tc = +25°C
60V	6.5mΩ @ V _{GS} = 10V	88A
60 V	10mΩ @ V _{GS} = 4.5V	73A

Description and Applications

This MOSFET is designed to minimize the on-state resistance (RDS(ON)) and maintain superior switching performance, which makes it ideal for high-efficiency power management applications.

- Power Management Functions
- DC-DC Converters
- Backlighting

Features

- 100% Unclamped Inductive Switching (UIS) Test in Production Ensures More Reliable and Robust End Application
- Low R_{DS(ON)} Minimizes Power Losses
- Low Q_q –Minimizes Switching Losses
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative.

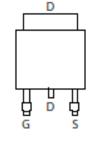
https://www.diodes.com/quality/product-definitions/

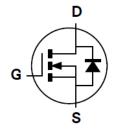
Mechanical Data

- Case: TO252
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 (§3)
- Weight: 0.33 grams (Approximate)









Top View

Pin Out Top View

Equivalent Circuit

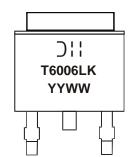
Ordering Information (Note 4)

Ì	Part Number	Case	Packaging
	DMT6006LK3-13	TO252 (DPAK)	2.500/Tape & Reel

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



The Manufacturer's Marking
T6006LK = Product Type Marking Code
YYWW = Date Code Marking
YY = Last Two Digits of Year (ex: 20 = 2020)
WW = Week Code (01 to 53)



Maximum Ratings (@ $T_A = +25^{\circ}C$, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Drain-Source Voltage	V _{DSS}	60	V
Gate-Source Voltage	Vgss	±20	V
Continuous Drain Current, V _{GS} = 10V (Note 6)	lD	88 71	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	I _{DM}	350	А
Maximum Continuous Body Diode Forward Current (Note 6)	Is	88	А
Pulsed Body Diode Forward Current (10µs Pulse, Duty Cycle = 1%)	Ism	350	Α
Avalanche Current, L = 0.1mH	las	28.5	Α
Avalanche Energy, L = 0.1mH	Eas	40.7	mJ

Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Total Power Dissipation (Note 5)	T _A = +25°C	PD	3.1	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	$R_{\theta JA}$	40	°C/W
Total Power Dissipation (Note 6)	T _C = +25°C	P _D	89.3	W
Thermal Resistance, Junction to Case (Note 6)	Rejc	1.4	°C/W	
Operating and Storage Temperature Range	TJ, TSTG	-55 to +150	°C	

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

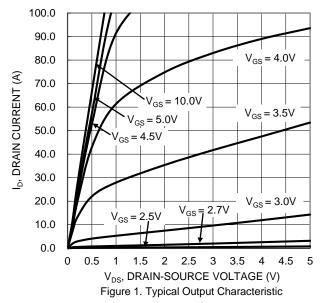
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV _{DSS}	60	_	_	V	$V_{GS} = 0V$, $I_D = 1mA$	
Zero Gate Voltage Drain Current	IDSS	_	_	1	μΑ	V _{DS} = 48V, V _{GS} = 0V	
Gate-Source Leakage	Igss	_	_	±100	nA	V _G S = ±20V, V _D S = 0V	
ON CHARACTERISTICS (Note 7)		•	•		•	•	
Gate Threshold Voltage	Vgs(th)	1.2	_	2.5	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$	
Static Drain-Source On-Resistance	D	_	5.1	6.5	mΩ	$V_{GS} = 10V, I_D = 20A$	
Static Drain-Source On-Resistance	RDS(ON)	_	7.1	10	11122	V _G S = 4.5V, I _D = 10A	
Diode Forward Voltage	VsD	_	0.8	1.2	V	Vgs = 0V, Is = 1A	
DYNAMIC CHARACTERISTICS (Note 8)		•	•		•	•	
Input Capacitance	Ciss	_	2162	_		V _{DS} = 30V, V _{GS} = 0V f = 1MHz	
Output Capacitance	Coss	_	761	_	pF		
Reverse Transfer Capacitance	Crss	_	58	_			
Gate Resistance	Rg	_	0.7	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge (V _{GS} = 4.5V)	Qg	_	18.1	_		V _{DD} = 30V, I _D = 20A	
Total Gate Charge (V _{GS} = 10V)	Qg		34.9				
Gate-Source Charge	Q _{qs}	_	6.1	_	nC		
Gate-Drain Charge	Qgd	_	7.3	_			
Turn-On Delay Time	tD(ON)	_	6.0	_		$V_{DD} = 30V, V_{GS} = 10V,$ $I_{D} = 20A, R_{q} = 3\Omega$	
Turn-On Rise Time	t _R	_	5.4	_			
Turn-Off Delay Time	tD(OFF)	_	20.4	_	ns		
Turn-Off Fall Time	t _F	_	7.8	_			
Reverse Recovery Time	trr	_	35.8	_	ns		
Reverse Recovery Charge	Qrr	_	40.2	_	nC	I _F = 20A, di/dt = 100A/μs	

Notes: 5. Device mounted on FR-4 substrate PCB, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.

7. Short duration pulse test used to minimize self-heating effect.
8. Guaranteed by design. Not subject to product testing.

^{6.} Thermal resistance from junction to soldering point (on the exposed drain pad).
7. Short duration pulse test used to minimize self heating effect.





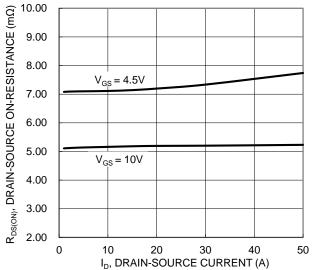


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

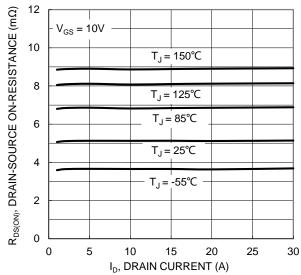
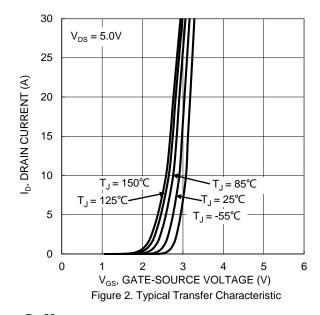
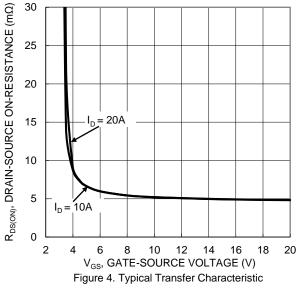


Figure 5. Typical On-Resistance vs. Drain Current and Temperature





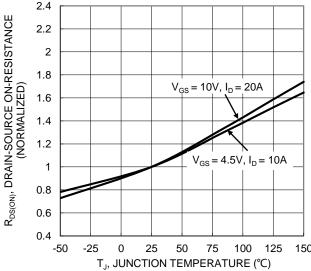


Figure 6. On-Resistance Variation with Temperature



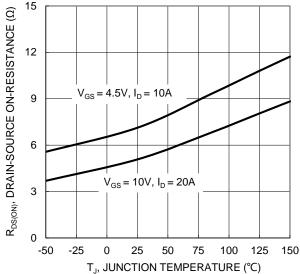


Figure 7. On-Resistance Variation with Junction Temperature

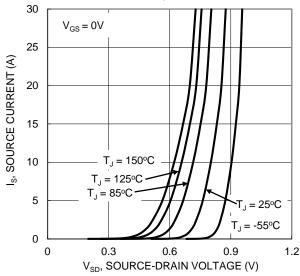
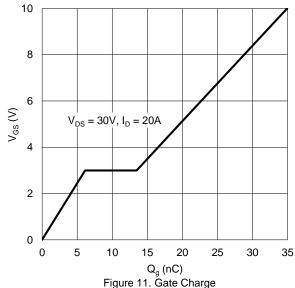


Figure 9. Diode Forward Voltage vs. Current



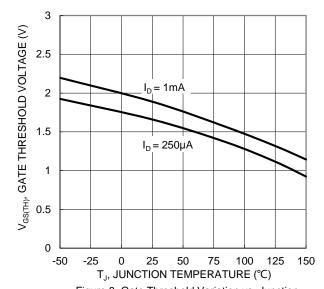


Figure 8. Gate Threshold Variation vs. Junction Temperature

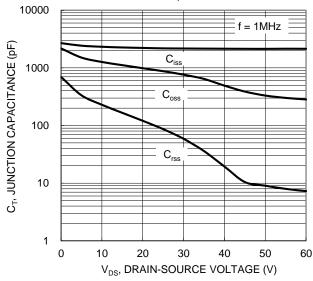
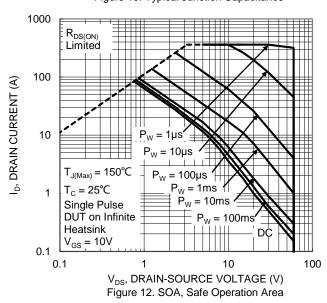


Figure 10. Typical Junction Capacitance





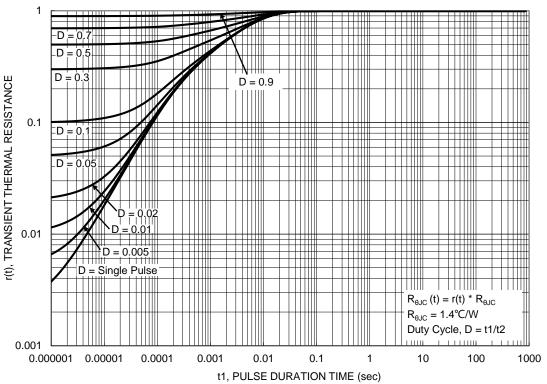


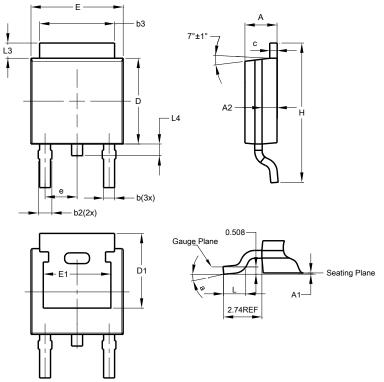
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

TO252 (DPAK)

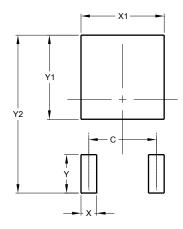


TOOSO (DDAI()						
TO252 (DPAK)						
Dim	Min	Max	Тур			
Α	2.19	2.39	2.29			
A 1	0.00	0.13	0.08			
A2	0.97	1.17	1.07			
b	0.64	0.88	0.783			
b2	0.76	1.14	0.95			
b3	5.21	5.46	5.33			
С	0.45	0.58	0.531			
D	6.00	6.20	6.10			
D1	5.21	1				
е	e 2.2		2.286			
Е	6.45	6.70	6.58			
E1	4.32	-	-			
Н	9.40	10.41	9.91			
L	1.40	1.78	1.59			
L3	0.88	1.27	1.08			
L4	0.64	1.02	0.83			
а	0°	10°	-			
All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

TO252 (DPAK)



Dimensions	Value (in mm)		
С	4.572		
Х	1.060		
X1	5.632		
Y	2.600		
Y1	5.700		
V2	10.700		



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